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A universal solution processed interfacial bilayer enabling ohmic contact in organic and hybrid optoelectronic devices†

Joel Troughton,^a Marios Neophytou,^a Nicola Gasparini,^a Akmaral Seitkhan,^a Furkan H. Isikgor,^a Xin Song,^a Yen-Hung Lin,^b Tong Liu,^b Hendrik Faber,^c Emre Yengel,^a Jan Kosco,^a Marek F. Oszajca,^c Benjamin Hartmeier,^c Michael Rossier,^c Norman A. Lüchinger,^c Leonidas Tsetseris,^d Henry J. Snaith,^b Stefaan De Wolf,^a Thomas D. Anthopoulos,^a Iain McCulloch^{a,e} and Derya Baran^a

Optoelectronic devices typically require low-resistance ohmic contacts between the optical active layers and metal electrodes. Failure to make such a contact often results in a Schottky barrier which inhibits charge extraction and, in turn, reduces device performance. Here, we introduce a universal solution processable metal-oxide/organic interfacial bilayer which forms a near-perfect ohmic contact between both organic and inorganic semiconductors and metals. This bilayer comprises a Nb-doped TiO₂ metal oxide with enhanced electron mobility and reduced trap density compared to pristine TiO₂, in combination with a metal-chelating organic molecule to make an intimate electrical contact with silver metallic electrodes. Using this universal interfacial bilayer, we demonstrate substantial efficiency improvements in organic solar cells (from 9.3% to 12.6% PCE), light emitting diodes (from 0.6 to 2.2 cd W⁻¹) and transistors (from 19.7 to 13.9 V threshold voltage). In particular, a boost in efficiency for perovskite solar cells (from 18.7% up to 20.7% PCE) with up to 83% fill factor is achieved with no-operational lifetime loss for at least 1000 hours under continuous, full-spectrum illumination.

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Broader context

Cathodic interfacial layers (CILs) serve to relieve electrical barriers present between semiconductors and metal electrodes in a broad range of electronic applications including photovoltaics, organic light-emitting diodes and transistors. In the absence of CILs, undesirable non-ohmic contacts can be formed which reduce the electrical performance of these devices. Here, we demonstrate a dual-action interfacial bilayer comprised of a metal oxide and organic small molecule, which makes a highly ohmic contact with a variety of semiconductors and metal electrodes: using this bilayer, we demonstrate performance improvements in perovskite and organic photovoltaics, as well as organic light-emitting diodes and thin-film transistors. The apparent universality of this bilayer opens new possibilities for highly effective, very low resistance contacts between metals and semiconductors using combinations of metal oxides and organic molecules.

Introduction

The formation of ohmic contacts between semiconductors and metals serving as electrodes is an important requirement for many electronic devices including solar cells,¹ thin-film transistors² and organic light emitting diodes (OLEDs).³ Non-ohmic contacts often feature undesired carrier-transport barriers (often called Schottky barriers) that lead to an accumulation of charges at the semiconductor/metal interface which, in turn, hinders electrical performance in many devices. As a result, several strategies have been developed to reduce the barrier at this interface through engineering of the interface states, as well as the work

^a King Abdullah University of Science and Technology (KAUST), KAUST Solar Center (KSC), Physical Sciences and Engineering Division (PSE), Thuwal, 23955-6900, Saudi Arabia. E-mail: joel.troughton@kaust.edu.sa, marios.neophytou@kaust.edu.sa

^b Department of Physics, Clarendon Laboratory, University of Oxford, Parks Road, Oxford OX1 3PU, UK

^c Avantama AG, Laubisrutistrasse 50, Stäfa, Switzerland

^d Department of Physics, National Technical University of Athens, 15780 Athens, Greece

^e Department of Chemistry, Imperial College London, SW7 2AZ, UK

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function and band offsets of interfacial materials, either aimed at efficient electron or hole collection. In silicon-based photovoltaics, Fermi-level pinning (FLP) at contacts has traditionally been suppressed by heavy doping at interfaces. Passivation layers, both organic and inorganic, have also been studied which suppress recombination and enhance carrier selectivity.^{4–6} In the case of OLEDs and organic photovoltaics (OPVs), thermally evaporated inorganic materials including MoO_3 and V_2O_5 , as well as Ca and LiF, have been employed as hole-transport and electron-transport layers (HTL and ETL), respectively.⁷ These materials are widely utilized owing to their suitable work functions and, depending on the device structure, optical transparency.⁸ However, the vacuum-processing requirements of these interfacial layers, combined with their sensitivity to ambient air, in some cases, makes their use in commercial applications limited.^{9,10} Thus, solution-processable organic interface materials have been widely investigated, with bathocuproine (BCP) and diphenylphosphine oxide (DPO)^{11,12} being among the most promising as ETLs in solution-processable solar cells. Conversely, electrode-surface modification treatments are favored in OFET devices, an example being the pre-treatment of a gold electrode with pentafluorothiophenol (PFBT) prior to the deposition of an organic semiconductor with a low lying highest occupied molecular orbital (HOMO).^{13–15} In the short time since their introduction, so-called ‘inverted’, p–i–n structured perovskite solar cells have employed a wide range of cathode interfacial layers (CILs): typically, fullerene C_{60} or [6,6]-phenyl- C_{61} -butyric acid methyl ester (PCBM) are inserted between perovskite and evaporated metal electrodes as ETLs.^{16–19} However, the tendency of fullerene materials’ to form a non-ohmic contact with these electrodes requires the presence of an additional inter-layer to nullify the barrier formed at this interface.^{20–22} To this end, metal oxides such as TiO_2 , SnO_2 , SrTiO_3 , ZnO and Al–ZnO as well as organic molecules such as BCP have been employed as CILs in perovskite solar cells.^{23–30} Clearly the formation of a barrier-free contact at this crucial interface is of interest to researchers spanning many fields with the aim of producing high-performance electronic devices.

In this work we present a universal solution processable metal-oxide/organic bilayer interface which forms a highly ohmic contact with metal electrodes in various optoelectronic devices such as organic and perovskite solar cells, light emitting diodes and transistors. This bilayer comprises a thin (<10 nm) layer of niobium-doped titanium dioxide nanoparticles (Nb-TiO_2 , in contact with the device’s semiconductor layer), capped by an ultra-thin layer of the organic small molecule bathocuproine (BCP, in contact with the device’s metal electrode). When deposited between either organic or inorganic semiconductors and metal cathode, this bilayer forms a quasiperfect ohmic contact with a contact resistance lower than either layer, when used in isolation. In the case of perovskite solar cells, this ohmic contact allows for a fill factor of 83%; among the highest reported for perovskite photovoltaics, as well as a large enhancement in operational stability under continuous full-spectrum illumination and inert atmospheric conditions.

Characterization of Nb-doped TiO_2

The addition of niobium (Nb) as a dopant for TiO_2 , specifically, was chosen given the relative similarity of the Ti^{4+} and Nb^{5+} ionic radii: this similarity allows for substitutional doping of Nb atoms into the TiO_2 lattice. The additional electron in Nb^{5+} compared to Ti^{4+} enables a higher electron mobility for Nb-TiO_2 .²⁶ TiO_2 doped with Nb has been demonstrated to be an efficient ETL in perovskite and dye-sensitised photovoltaics, as well as in photocatalytic applications and battery electrodes, given its improvement in carrier density over pristine TiO_2 .^{31–41} Light and dark field transmission electron microscopy (TEM) images of TiO_2 nanoparticles (Fig. 1a and b, respectively) exhibit a lattice spacing of 0.29 nm between both $\{2\ 1\ 1\}$ and $\{-2\ 1\ -1\}$ planes, with an average nanoparticle size of 7 nm. The lattice spacing in both pristine and Nb-doped TiO_2 (5 mol% Nb inclusion, Nb-TiO_2) is identical, as presented in the TEM images in Fig. 1c and d (further illustrated in Fig. S1, ESI†). This is to be expected if substitutional mixing is present given the similarity of ionic radii.

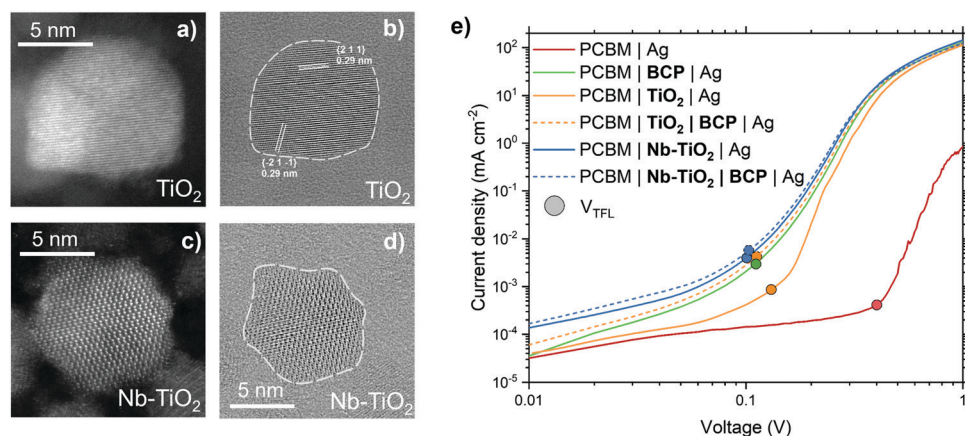


Fig. 1 Light and dark-field TEM micrographs of pristine TiO_2 (a and b) and Nb- TiO_2 (c and d) nanoparticles. (e) Current–voltage curves for ‘electron only’ devices with different interfacial layers between PCBM–Ag contacts at logarithmic scale, measured in the dark. Solid circles indicate the trap-filled limit voltage (V_{TFL}) for each configuration. The structure of the device is comprised as follows: ITO/ SnO_2 /MAPbI₃/PCBM/interfacial layer/Ag.



Cathodic interfacial layers between PCBM and the metal electrode minimize the Schottky barrier that is often formed between a metal and a semiconductor, due to FLP, leading to a non-ohmic contact.⁴² This electrical barrier can be overcome by the introduction of very thin (<10 nm) layer between PCBM and metal, with metal oxides and organic small molecules being common choices aimed at reducing the defect and metal induced gap state density, between metal and semiconductor, which causes FLP.⁶ A simple and accessible method to probe the ohmic contact at this interface is to fabricate so-called 'electron-only' devices with different interfacial layers. Fig. 1e shows the current-voltage response for $\text{CH}_3\text{NH}_3\text{PbI}_3$ (MAPbI₃)-containing electron-only devices, measured in the dark, employing different PCBM-to-metal interlayers. With Ag in direct contact with PCBM, the electrical response is highly non-ohmic. A shallow slope in the ohmic region below 0.1 V, combined with a high trap-filled limit voltage (V_{TFL} , the point at which the slope of the curve increases, indicated by a solid circle) is indicative of a Schottky barrier.⁴³ With the addition of a layer of BCP,^{22,44,45} the ohmic response of the device is greatly improved, shown by the dramatically reduced V_{TFL} . The increase in V_{TFL} observed when using a TiO_2 interlayer, compared to that of BCP, suggests the presence of trap-states within pristine TiO_2 . In the case of Nb-TiO₂, a substantial improvement in this parameter is observed, suggesting that the addition of Nb both improves electron mobility and reduces the trap density within the metal oxide.³⁷ While the addition of Nb reduces the resistance of this interlayer, we find the electrical properties of this interface can

be further improved upon the addition of a layer of BCP, forming a Nb-TiO₂/BCP bilayer. This bilayer yields a lower-resistance to electron transfer than either the Nb-TiO₂ or BCP layers when used individually. The addition of BCP further reduces the slight Schottky barrier formed between Nb-TiO₂ and metal electrode. This is the result of BCP's tendency to chelate with metals commonly used as electrodes such as silver, allowing a more intimate electronic contact between the Nb-TiO₂ nanoparticles and the metal conductor. We propose that this bilayer reduces the FLP between ETL and metal, whilst offering enhanced carrier selectivity than BCP alone. The result is a bilayer which provides a highly versatile interface to couple semiconductors with metallic electrodes for high performance electronic and optoelectronic devices.

Interfacial bilayer simulation

To uncover the working mechanism of the Nb-TiO₂/BCP bilayer we performed density functional theory (DFT) calculations. Fig. 2a shows simulated electronic density of states (DOS) plots for TiO₂ with substitutional Nb atoms at Ti sites (1 in 8 Ti sites replaced with Nb, $x_{\text{Nb}} = 0.125$). The Fermi levels of all three TiO₂ polymorphs (anatase, rutile and brookite, with brookite being the system of interest in this study) are shifted inside the conduction band of the material. This makes Nb-TiO₂ somewhat metallic in nature, in agreement with previous studies.^{46,47} Even for the relatively high concentrations of Nb ($x_{\text{Nb}} = 0.125$), substitutional doping imparts minimal changes (around 1% or less) in the lattice parameter of brookite TiO₂ (Fig. S2, ESI†).

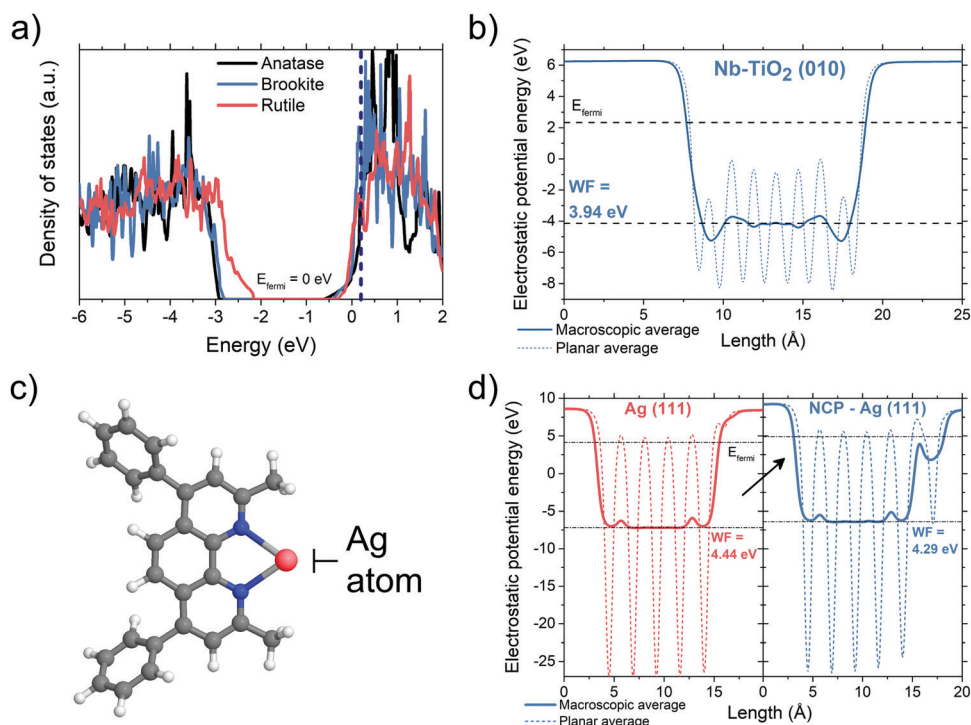


Fig. 2 (a) Calculated electronic density of states for different TiO₂ polymorphs doped with 12.5% Nb. (b) Calculated electrostatic potential energy for a (010) surface of brookite Nb_{0.125}Ti_{0.875}O₂ showing a predicted work function of 3.94 eV. (c) Structure of bathocuproine (BCP) chelated with a silver atom. (d) Calculated electrostatic potential energies and work functions for a silver (111) surface (red trace) and the same silver surface with a layer of neocuproine (blue trace).



This is experimentally confirmed by the lack of lattice spacing differences between Nb-TiO₂ and TiO₂ observed in the TEM micrographs of Fig. 1a–d, where a much-reduced x_{Nb} of 0.05 is used. For brookite Nb-TiO₂, we calculated the electrostatic potential for the (010) termination (Fig. 2b, other surfaces shown in Fig. S3 and S4, ESI†). From these simulations, we determined the work function of the (010) surface to be 3.94 eV. This shows that there is at least one surface of brookite Nb-TiO₂ with a work function well-aligned with the lowest unoccupied molecular orbital (LUMO) of PCBM (3.9 eV) and less than the work function of the Ag electrode.^{16,48,49} This value also shows good agreement with our experimentally derived work function of 3.8 eV (Fig. S5, ESI†) and is consistent with the facile transfer of electrons from PCBM to Nb-TiO₂.

Next, we probed the role of BCP in this interfacial structure. We found that BCP has a relatively low-lying HOMO energy around -6.07 eV (Fig. S6, ESI†). Moreover, we found that BCP molecules are able to chemically bond with Ag atoms (Fig. 2c) and hence suppress Ag diffusion towards the active layers of the device – which was previously found to be a cause of device degradation.^{50,51} This chelation effect is also well-known for the molecule neocuproine (NCP), which is an analogue of BCP containing identical metal-binding groups (shown in Fig. S7, ESI†) whilst being significantly faster to model.⁵² To explore the role of BCP–Ag interactions (equivalently, NCP–Ag interactions), we simulated the adsorption of NCP on an Ag (111) surface containing adatoms. The high adsorption energies in this system ($E_b = 2.15$ eV and 2.82 eV for pristine and adatom-containing surfaces respectively, Fig. S8, ESI†) indicate that NCP (and consequently BCP) molecules can efficiently functionalize the Ag surface. This decreases the work function of Ag(111) by

approximately 0.15 eV as shown in the electrostatic simulations of Fig. 2d (as well as Fig. S9 for other Ag surface configurations, ESI†), bringing it closer to the LUMO energy of PCBM and the work function of Nb-TiO₂. To summarize the DFT-based results: (1) Nb-doped TiO₂ is at least partially metallic, hence gap states are suppressed, (2) the addition of an additional BCP layer can block hole propagation and Ag diffusion, (3) the work functions of Nb-TiO₂ and BCP-functionalized Ag surfaces are well-aligned with the LUMO level of PCBM, allowing a very low resistance ohmic contact between semiconductor and metal electrode.

Perovskite photovoltaic device performance

Fig. 3a shows a cross-section TEM micrograph of a perovskite solar cell used in this study in an ‘inverted’ p–i–n structure using a device stack containing NiO_x HTL, MAPbI₃ perovskite absorber, and PCBM ETL. We spin-coat a thin layer (<10 nm) of TiO₂ or Nb-TiO₂ nanoparticles to act as a CIL, as evidenced in the high magnification of Fig. 3b. Where appropriate, an additional ultra-thin layer of bathocuproine is employed between the metal oxide nanoparticles and electrode to further improve the ohmic contact. The resulting current–voltage (J – V) characteristics of the above “p–i–n” configuration MAPbI₃ perovskite solar cells are present in Fig. 3c–e and summarized in Table 1. We note that device series resistance (R_s) is reduced upon the addition of BCP in the case of both pristine TiO₂ (from 3.8 to 1.8 Ω cm⁻²) and Nb-TiO₂ (from 3.5 to 1.1 Ω cm⁻²).⁵³ This trend is in close agreement with the electron-only findings in Fig. 1e, and shows a substantial reduction in device series resistance as a result of the Nb-TiO₂–BCP bilayer compared to BCP alone.

Forward and reverse J – V scans can be seen in Fig. S10 (ESI†) and indicate a minimal degree of hysteresis. Statistical accounts

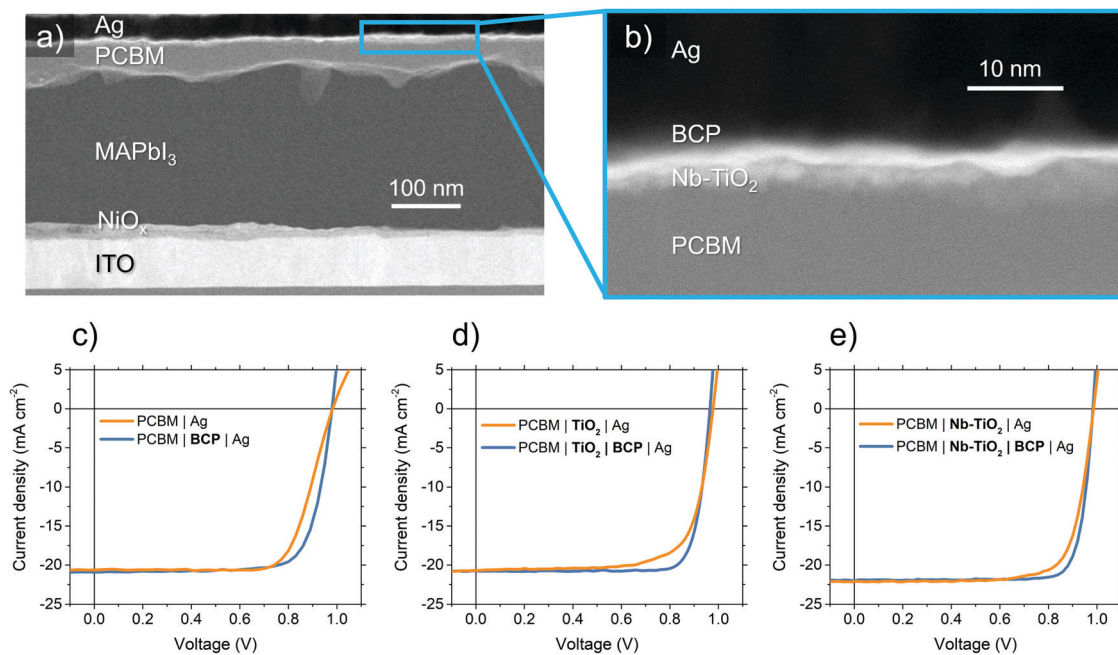


Fig. 3 (a and b) Cross-sectional TEM micrographs of perovskite solar cells employing the Nb-TiO₂ and BCP bilayer interfacial bilayer. (c–e) Current–voltage curves for perovskite solar cells employing different interfacial layers between PCBM charge selective layer and Ag electrode. Expanded J – V traces including information on hysteresis may be found in Fig. S10 (ESI†).



Table 1 Average key parameters of perovskite solar devices using various interfacial layers between PCBM and Ag electrode. Values reported inside brackets for the highest PCE devices

ITO NiOx MAPbI ₃	J_{SC} (mA cm ⁻²)	V_{OC} (V)	FF	PCE (%)	R_s (Ω cm ⁻²)
PCBM Ag	19.7 (20.6)	0.96 (0.98)	0.71 (0.73)	13.5 (14.9)	(8.5)
PCBM BCP Ag	20.1 (20.9)	0.97 (0.98)	0.77 (0.78)	14.5 (15.8)	(3.1)
PCBM TiO ₂ Ag	20.4 (20.6)	0.98 (1.00)	0.74 (0.75)	14.6 (15.2)	(3.8)
PCBM TiO ₂ BCP Ag	20.7 (21.0)	0.98 (1.00)	0.79 (0.80)	15.6 (16.1)	(1.8)
PCBM Nb-TiO ₂ Ag	21.5 (22.1)	0.97 (0.98)	0.76 (0.77)	16.2 (16.7)	(3.5)
PCBM Nb-TiO ₂ BCP Ag	21.8 (22.5)	0.99 (1.00)	0.82 (0.83)	17.6 (18.5)	(1.1)

of cell parameters are found in Fig. S11–S13 (ESI[†]) showing on-average differences in device performance. When BCP is introduced as the sole interfacial layer, as in Fig. 3c, the Schottky barrier is largely removed and the fill factor is increased from 0.73 to 0.78. While the use of a TiO₂ interfacial layer yields results similar to that of BCP (Fig. 3d), the Nb-TiO₂-containing device shows a substantial increase in J_{SC} (from 20.6 to 22.1 mA cm⁻², Fig. 3e). This increase in J_{SC} and fill factor from pristine to Nb-doped TiO₂ was also observed in an article by Chen and coworkers when employing Nb-TiO₂ as an ETL in “n-i-p” perovskite solar cells.⁵⁴ owing to a reduction in charge trapping within the metal oxide interlayer.

Fig. 4 illustrates this trapping using a transient photocurrent technique (TPC, Fig. 4a): with the pristine TiO₂ device, a spike in transient photocurrent is observed. The same spike is absent in devices containing Nb-TiO₂. This trapping effect is also observed in the solar cell external quantum efficiency (EQE, Fig. 4b) where devices with either a TiO₂ interlayer or no interlayer exhibit a drop in response at longer wavelengths (> 700 nm) compared to devices containing Nb-TiO₂. Reduced EQE response in this region is correlated to increased recombination at the “rear” interface of the device, *i.e.* the perovskite/PCBM/interlayer interface. Since the perovskite/PCBM interface is unchanged in all cases, the role of Nb-doping in this system is therefore to both passivate TiO₂ surface traps as well as to enhance the electron mobility of the nanoparticle film, reducing the barrier at the PCBM/Ag interface. Crucially, the addition of a secondary BCP layer greatly improves fill factor in devices with either a TiO₂ (Fig. 3d) or Nb-TiO₂ (Fig. 3e) interfacial layer, with the latter device exhibiting fill factors up to 0.83 in either J - V scan direction without negatively impacting other performance figures of merit. This significant fill factor is achieved both as a result of the reduction in trap density within the metal nanoparticle from Nb-doping, as well as BCP's work function modification of the Ag electrode, leading to a barrier-free interface. When measured over a range of illumination intensities, the fill factor response of TiO₂ + BCP and Nb-TiO₂ + BCP containing devices remains consistent between 0.80 and 0.84 (Fig. 4c). This is in comparison to a device containing no interlayer which shows a strong dependence on light intensity, suggesting a charge extraction limitation which is not present in the metal oxide-containing devices. A full account of current-voltage parameters as a function of light intensity may be found in Fig. S14 (ESI[†]). The solar cell fill factor values demonstrated here are among the highest currently reported for perovskite solar cells,^{55,56} indicating a highly ohmic contact between PCBM and silver electrode in interfacial bilayer devices,

with particularly low contact resistance. Interestingly, an improvement in device performance is also observed when employing other commonly used electrode metals such as copper and gold in conjunction with Nb-TiO₂ + BCP. Fig. S15 and Table S1 (ESI[†]) shows an increase in photocurrent density employing the bilayer in a device with a copper electrode, while gold electrode devices show an additional increase in fill factor (from 0.76 to 0.79) upon the addition of Nb-TiO₂. Furthermore, the slope of the trap-filling region in electron-only devices is steeper for copper and gold electrodes when the interfacial bilayer is used (Fig. S15c and d, ESI[†]).

While NiOx HTLs have been proven to yield high fill factors in PSCs, polymers such as poly(triarylamine) (PTAA) and poly(4-butylphenyldiphenylamine) (poly-TPD) have emerged as more efficient alternatives given their high hole mobility and electron blocking properties.^{57–59} For MAPbI₃ devices employing a PTAA HTL and Nb-TiO₂/BCP cathodic bilayer, we demonstrate PCEs up to 20.7% in the “reverse” J - V scan direction, and 20.6% after 100 seconds held at maximum power voltage (Fig. 4e, f and Fig. S17, ESI[†]). This is compared to a BCP-only device with PCEs up to 19.3%. A full statistical account of these devices and their hysteresis may be found in Fig. S16 and S17 (ESI[†]). Further, to demonstrate that perovskite compositions beyond MAPbI₃ may be used in this structure, we also fabricated devices using a multi-cation multi-anion perovskite composition [Cs_{0.05}(FA_{0.83}MA_{0.17})_{0.95}PbI_{2.7}Br_{0.3}]. Corresponding J - V curves may be found in Fig. S18 (ESI[†]), with the bilayer containing device yielding 19.4% compared to 17.6% for a BCP-only device. It is worth noting that the 3 device structures (NiOx-MAPbI₃, PTAA-MAPbI₃, poly-TPD-Mixed cation & anion perovskite) demonstrated here were fabricated by different researchers on different days and, in the case of the latter, different universities: given the statistically significant performance improvement across a range of fabrication variables, we are confident of the proposed bilayer's efficacy in perovskite photovoltaics.

We find that perovskite solar cell operational stability is greatly improved upon the addition of this interfacial bilayer (Fig. 4d and Fig. S19, ESI[†]): under 1 sun continuous illumination (lamp spectrum presented in Fig. S20, ESI[†]) at open-circuit conditions in a nitrogen atmosphere maintained at 35 °C, MAPbI₃ devices employing the Nb-TiO₂/BCP bilayer retained their initial efficiency after 1000 hours. This is compared to devices containing only BCP which fall to 60% of their original efficiency during the same period. This decrease is primarily the result of a loss in fill factor and is attributed to metal electrode migration through the PCBM electron transport layer.⁶⁰ The presence of a



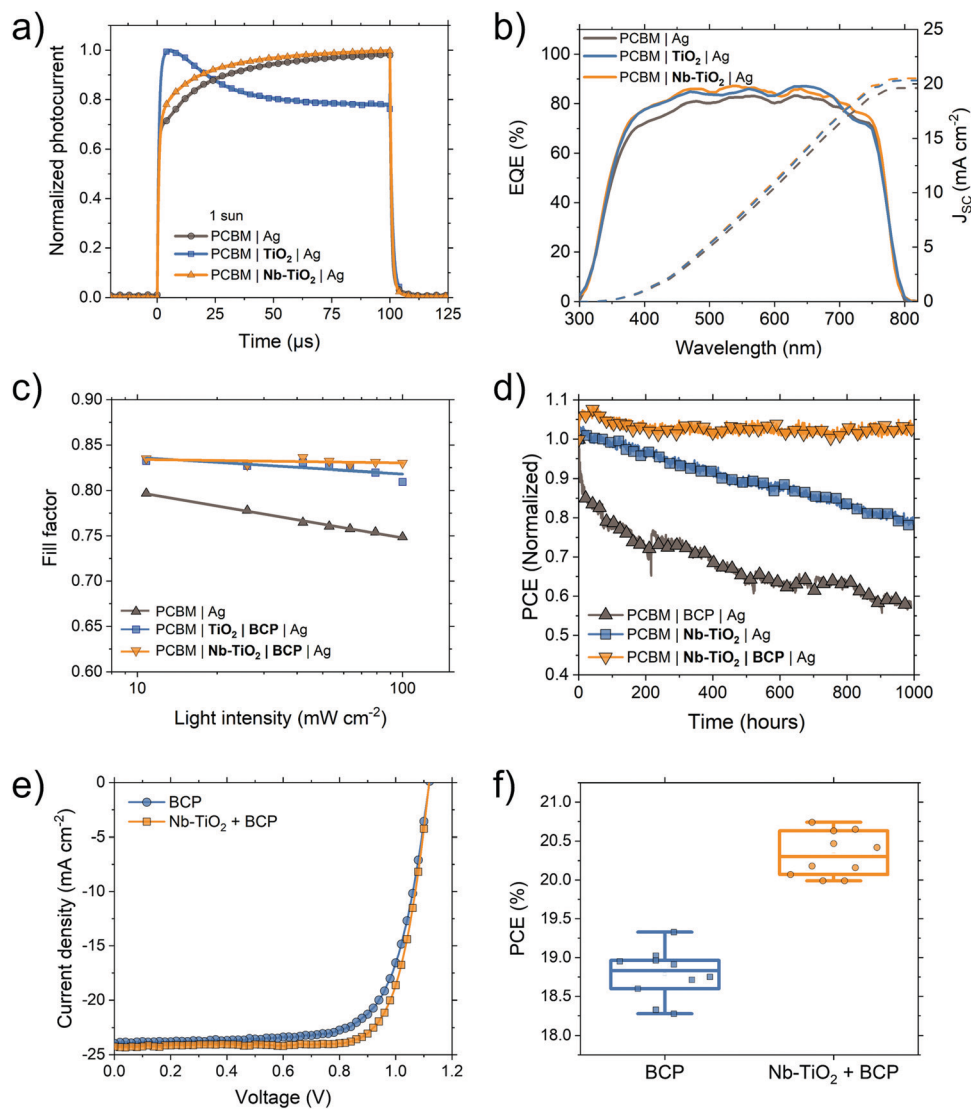


Fig. 4 Transient photocurrent measurements (a), external quantum efficiency (b), and fill factor as a function of light intensity for different metal oxide nanoparticle interfacial layers (c). Also included is solar cell stability under a nitrogen atmosphere and 1 sun illumination (d). J - V curves from champion perovskite devices employing a PTAA HTL both with and without the interfacial bilayer (e). PCE statistics for PTAA HTL devices ((f), $n = 10$ for each interlayer).

layer of metal oxide nanoparticles effectively blocks this migration, leading to the stabilization of the device's fill factor. The addition of an ultra-thin layer of silver-cheating BCP on top of this metal oxide layer further arrests metal migration over this test period, leading to highly stable perovskite solar cells under constant illumination.

Universality of Nb-TiO₂/BCP layer in optoelectronic devices

The Nb-TiO₂/BCP bilayer is applicable to electronic devices beyond perovskite solar cells. Here we extend this mechanism to other organic semiconductors such as those found in OPVs. In the OPV devices illustrated in Fig. 5a and 6d, an aluminum-coated calcium electrode is replaced with the Nb-TiO₂/BCP bilayer and silver electrode. With no interfacial layer between organic active layer and silver, charge selectivity is reduced as demonstrated by the low V_{OC} in Fig. 5a, by silver penetration

into the organic active layer during thermal evaporation, as previously reported.⁶¹ J - V parameters, statistics and EQE spectra for all devices listed in Table S2 and Fig. S21, S22 (ESI[†]), respectively. Upon the addition of a Nb-TiO₂ interlayer between the bulk heterojunction and silver electrode, V_{OC} is improved by over 70 mV due to the mechanical separation of metal and active layer – preventing silver penetration and subsequent de-rectification. However, the shortfall in V_{OC} from the energetically-expected value indicates a barrier still present at the metal-oxide/metal interface. The combination of Nb-TiO₂ and BCP at this interface leads to a further improvement in all photovoltaic parameters and an overall PCE of 12.6% – among the highest reported for this active layer combination. With the suppression of any Schottky barrier between active layer and electrode, the fill factor is improved from 0.63 to 0.72. The improvement in charge selectivity at this interface also improves



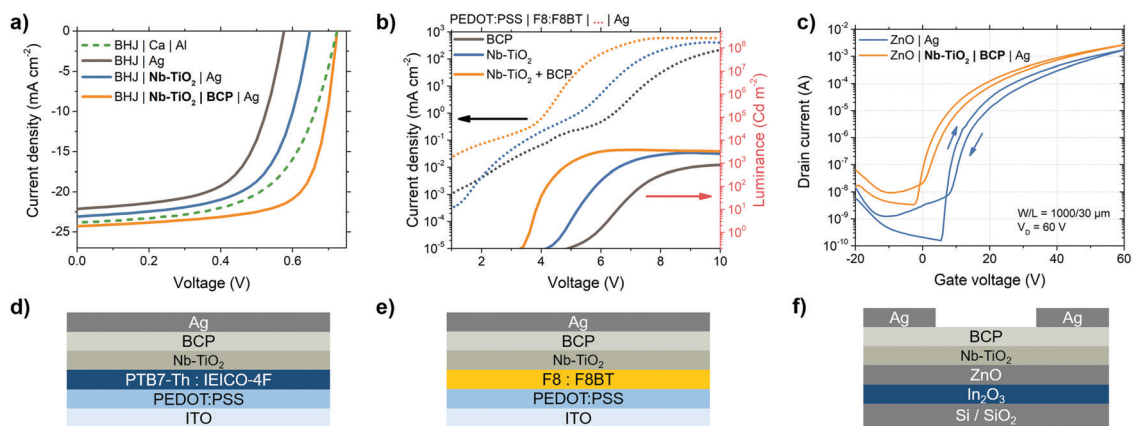


Fig. 5 (a and d) Device structure and current–voltage curves for ‘normal’ p–i–n structure organic solar cell devices employing the metal oxide organic bilayer as an interface between semiconductor and metal electrode. (b and e) Device structure and current–luminance–voltage curves for organic LEDs employing various interfaces between semiconductor and metal electrode. (c and f) Device structure and current–voltage curves for inorganic thin-film transistors employing different semiconductor–metal interfaces.

V_{OC} further to 0.72 V; comparable to the highest reported efficiency n–i–p structure devices, which typically exhibit higher overall performance.^{62,63} The use of this bilayer layer is, therefore, a useful component for efficient “p–i–n” OPV devices with high fill factors for simple binary blends, without the use of an easily-oxidized Ca/Al electrode.

To further prove the applicability of this interface, Fig. 5e illustrates the structure of an OLED device containing a blend of poly(9,9-di-*n*-octylfluorenyl-2,7-diyl) (F8) and poly(9,9-dioctylfluorene-*alt*-benzothiadiazole) (F8BT) emitters followed by the Nb-TiO₂ & BCP bilayer. Fig. 5b shows a current–voltage–luminance comparison between OLEDs employing combinations of the studied bilayer: when the Nb-TiO₂/BCP bilayer is used, the emission turn-on voltage (dashed line) is reduced compared to a BCP-only device, resulting from the low barrier interlayer between emitter and metal electrode. This interface permits higher current injection at lower voltages, leading to an overall improvement in luminous efficiency (solid line): for this bilayer-containing OLED, peak luminous efficiency occurs at 4.3 V with 2.2 cd W⁻¹ compared to the a BCP–Ag electrode device with a peak efficiency of 0.08 cd W⁻¹ at 10.2 V (Fig. S23–S25, ESI[†]). This improvement in ohmic contact when using the Nb-TiO₂/BCP bilayer is also applicable to thin film transistors (TFTs): Fig. 5f illustrates the schematic representation of such a transistor employing a silicon gate electrode and a semiconductor heterojunction of In₂O₃ and ZnO.⁶⁴ In their standard configuration, metal source and drain electrodes directly contact the ZnO semiconductor. However, as demonstrated in Fig. 5c, the presence of the interfacial bilayer between ZnO and silver electrodes significantly reduces the transistor’s threshold voltage (from 19.7 to 13.9 V – corresponding to a reduction of interfacial trap density of 1.3×10^{12} cm⁻²) and shifts the turn-on voltage closer to 0 V. A statistical account of TFT threshold voltages for all bilayer material combinations can be found in Fig. S26 (ESI[†]). The same performance improvement is observed in other TFT configurations such as those employing single-oxide semiconductors, and self-assembled monolayer (SAM)-functionalized metal gate electrodes

(Fig. S27, ESI[†]). This reduction in turn-on voltage in simple TFTs is yet another indication that the electronic barrier between semiconductor and metal electrode is reduced as a result of the Nb-TiO₂–BCP interlayer.

To conclude, we find that the addition of a solution processable bilayer of Nb-TiO₂ nanoparticles in combination with a thin layer of organic BCP at the interface between semiconductor and metal electrode effectively reduces the Schottky barrier formed in a range of electronic device types and structures. We demonstrate that the versatility of this novel metal oxide–organic interface extends beyond perovskite and organic solar cells with other devices including OLEDs and TFTs exhibiting improvements in their figures of merit. The introduction of a low trap-density electron-selective metal oxide, Nb-TiO₂, in contact with the device-side semiconductor facilitates efficient electron transfer. Meanwhile, the addition of BCP functionalizes the silver electrode’s surface and brings its work function into more favorable energetic alignment with respect to many organic or inorganic semiconductors. The result of this bilayer is largely barrier-free electron injection from semiconductor into the external circuit, as well as dramatically improved operational stability in the case of perovskite solar cells. This new strategy paves the way for more efficient optoelectronic devices to be fabricated without an additional vacuum processing step, whilst opening a new avenue of research to find even more effective combinations of metal oxides and organic compounds to form into such a bilayer for high efficiency and stable optoelectronic devices.

Author contributions

J. T. and M. N. share equal contribution for conceiving the idea, designing the experiments and fabricating perovskite solar cells. M. N. fabricated and characterized OLEDs, N. G. performed electrical characterization of perovskite photovoltaics and aided in the design of experiments. L. T. performed the DFT calculations on Nb-TiO₂ and BCP. M. F. O., B. H., M. R., and N. A. L. synthesized



the metal oxide materials, A. S. performed electron microscopy, X. S. fabricated and characterized organic photovoltaics, E. Y. built the OLED characterization system. F. I. fabricated polymer HTL perovskite photovoltaics and antireflective coatings. Y.-H. L. and T. L. fabricated and characterized mixed cation perovskite photovoltaics, H. F. fabricated and characterized thin-film transistors, J. K. synthesized emitter materials for OLEDs. All co-authors discussed the paper and revised the manuscript. T. A., I. M. and D. B. supervised the work. J. T. wrote the manuscript.

Conflicts of interest

D. B., N. G. and J. T. are co-founders of Iyris, L. L. C. H. J. S. is co-founder and Chief Scientific Officer of Oxford PV Ltd.

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